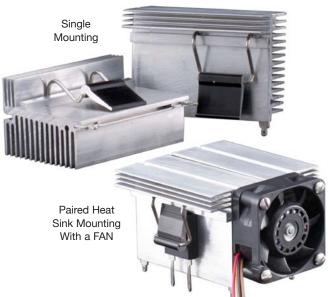
# C40 Heat Sink System

For TO-247, TO-264 and SOT-227 Packages

The C40 Series Heat Sink System (Patent Pending) offers flexible, high performance and compact heat sinks with an exchangeable cam clip system for T0-247, T0-264 and S0T-227 (clip in development) devices. This powerful heat sink can be thru-hole soldered in single or paired configurations. The paired unit has mounting holes to accomodate a 40mm x 40mm fan. It is the ideal type of heat sink for high power density and small size (1U or 2U) electronic packaging with forced convection.



#### SERIES SPECIFICATIONS

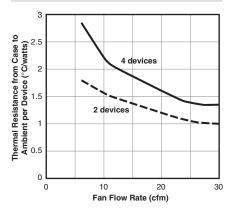
Heatsink	Surface Area	Weight	Length L
Part Number	(in² / mm²)	(oz / g)	(mm)
C40-058-VE C40-058-AE	63.8 / 41,180	2.5/71	58

consult factory for alternate lengths and clip combinations

#### **CHARACTERISTICS**

Heat Sink	Aluminum Alloy 6063-T5 or Equivalent with either degreased or black anodized finish.
Spring Clip	Music Wire, Per ASTM A228 with bright nickel plating
Solder Foot	Cold-rolled Steel, Per ASTM A-366 with pure tin over copper strike. RoHS compliant.
Fan	40mm fan with 4 self-tapping M3 screws
Interface Thermal Resistance	For improvement, use thermal joint compound, 0.005 Grafoil (TGon 800 by Laird), or phase change material (Hi-Flow by Bergquist) Insulator (Optional) Sil-Pad 900-S, K6 800-S and K10 by Bergquist

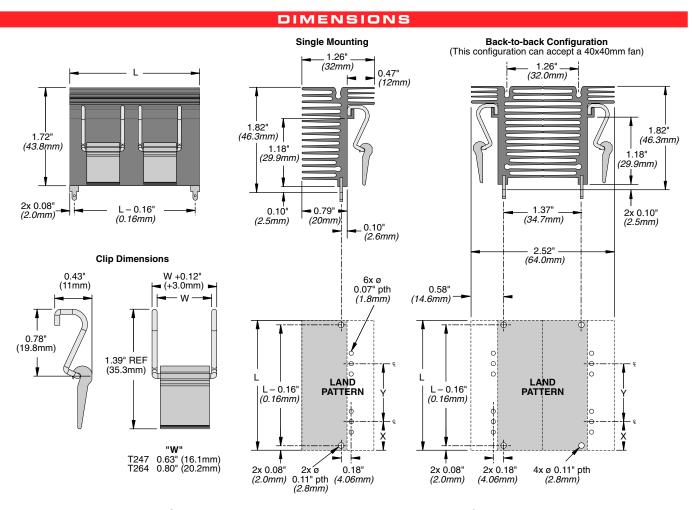
#### **Heat Dissipation**





## C40 Heat Sink System

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NOTE: Due to possible screw torquing on long extrusions, Customer should check for coplanarity prior to final assembly or soldering.

#### HOW TO ORDER

